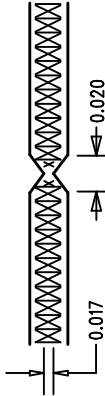


REVISIONS		
REV	DESCRIPTION	APPR

- LAYER 1 (COMPONENT SIDE)
- LAYER 2 (GND)
- LAYER 3
- LAYER 4 (SOLDER SIDE)

NOTES : Unless Otherwise Specified

- PCBs ARE TO BE RoHS COMPLIANT
- MATERIAL : FR4 OR EQUIVALENT EPOXY
2 OZ OUTER, 1 OZ INNER COPPER CLAD
THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS
 - FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE
- GOLD IMMERSION BOTH SIDES.
- SOLDER MASK OVER BARE COPPER (SMOBC)
 - SOLDER MASK : BOTH SIDES USING RED LPI OR EQUIVALENT
 - SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK
 - SCORING (FOR PRODUCTION RUN)



- DO NOT ALTER ARTWORK e.g. TO ADD LOGO OR DATE CODE,
BUT YOU MAY MODIFY PAD SIZE TO MEET END FINISH

FAB DRAWING

APPROVALS

DRAWN	INIT	DATE
CHECK		
DESIGN	Antonino K	4/13/07
ENGR	Mark Gurrles	4/13/07

1630 McCarthy Blvd.
Milpitas, CA 95035
PH: (408)432-1900

TITLE: LTC4110EUHF
Battery Backup System Manager

SIZE	A	DEMO	DC1259A	REV.	A
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SCALE = NONE

SHT 1 of 1